

L Number	Hits	Search Text	DB	Time stamp
1	4302	((118/52,56,58,62,63).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 11:29
2	17	((118/52,56,58,62,63).CCLS.) and (showerhead or (shower adj head) or ((dispers\$3 or distribut\$3) adj plate)) and (substrate or wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 11:37
3	17	((118/52,56,58,62,63).CCLS.) and (showerhead or (shower adj head) or ((dispers\$3 or distribut\$3) adj plate)) and (substrate or wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 11:45
4	247	((118/52,56,58,62,63).CCLS.) and (mesh or screen or filter) and (substrate or wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 11:56
5	48	((118/52,56,58,62,63).CCLS.) and ((mesh or screen or filter) with (gas or vapor)) and (substrate or wafer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 11:48
6	46	((118/52,56,58,62,63).CCLS.) and ((mesh or screen or filter) with (gas or vapor)) and (substrate or wafer)) not ((118/52,56,58,62,63).CCLS.) and (showerhead or (shower adj head) or ((dispers\$3 or distribut\$3) adj plate)) and (substrate or wafer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 11:48
7	7	((118/52,56,58,62,63).CCLS.) and (mesh or screen or filter) and ((substrate or wafer) same chuck) and (inlet same source)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 12:00
8	2	((118/52,56,58,62,63).CCLS.) and (mesh or screen or filter) and ((substrate or wafer) same chuck) and (inlet same source)) not ((118/52,56,58,62,63).CCLS.) and ((mesh or screen or filter) with (gas or vapor)) and (substrate or wafer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 12:01
9	2	("6287987").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2002/09/30 12:02